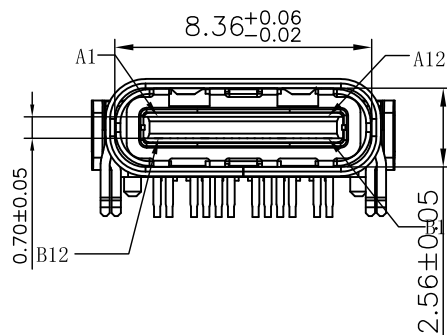
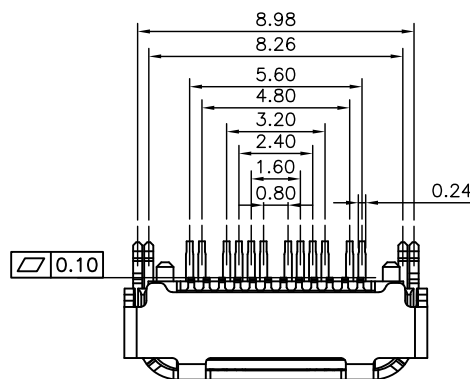
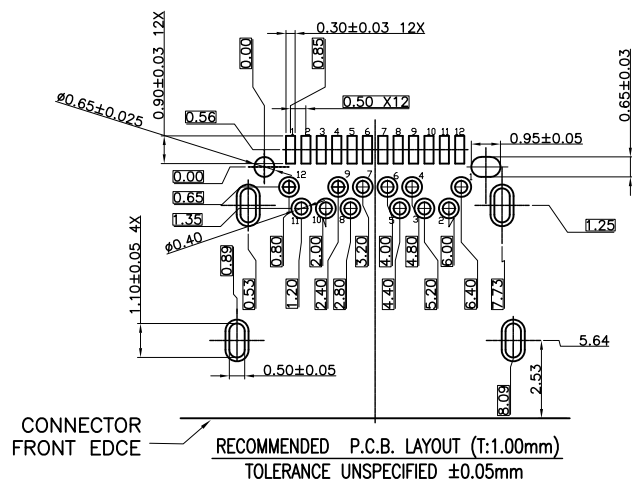
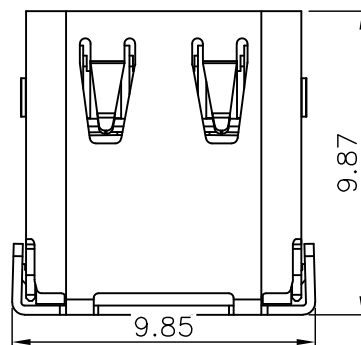
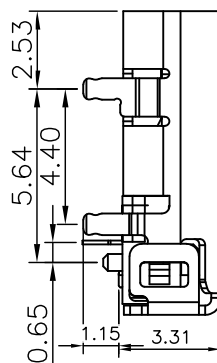
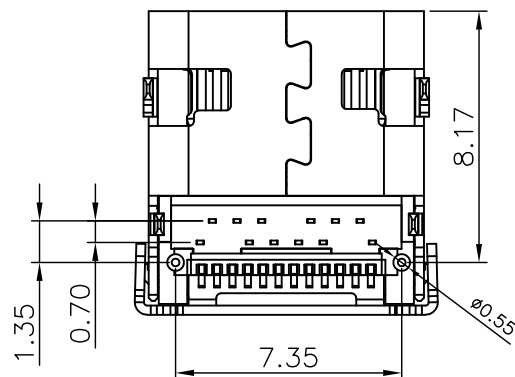


PIN	NUMBER	SIGNAL	NAME	PIN	NUMBER	SIGNAL	NAME
	A1		GND		B12		GND
	A2		SSTXp1		B11		SSRXp1
	A3		SSTXn1		B10		SSRXn1
	A4		VBUS		B9		VBUS
	A5		CC1		B8		SBU2
	A6		Dp1		B7		Dn2
	A7		Dn1		B6		Dp2
	A8		SBU1		B5		CC2
	A9		VBUS		B4		VBUS
	A10		SSRXn2		B3		SSTXn2
	A11		SSRXp2		B2		SSTXp2
	A12		GND		B1		GND



备注:

1. 材质:

1.1 胶芯: LCP+30%G.F UL94V-0

1.2 端子: 高导铜C7025, T=0.15mm; 镍底50U"
MIN,

接触区域镀金 (AU 1u") 焊接区镀金G/F

1.3 外壳: SUS304, T=0.30mm; 表面镀镍30U" MIN

1.4 中夹片: SUS301, $T=0.15\text{mm}$;

2.主要特性:

2.1 额定电流: 5A

2.2接触阻抗: 40mΩ MAX(初始值)
50mΩ MAX(测试后)

2.3绝缘阻抗: 100M Ω MIN

2.4耐压测试: 100V AC R.M.S.

2.6整体插入力: 5-20N 整体插入力: 5-20N (耐久后)

整体拔出力:8-20N 整体拔出力:6-20N (耐久后)

2.7耐久：10000次

2.8耐高温: SMT 回流焊 (峰值 $260^{\circ}\pm 5^{\circ}$), 塑胶不能有起泡,

融胶等不良,变色,翘曲变形在公差范围以内;

2.9产品须做焊锡测试,粘锡面积达到95%以上;

3.0盐雾测试: 48H MIN

3.1 工作温度: $-30^{\circ}\text{C} \sim +85^{\circ}\text{C}$



深圳市华宇创精密电子有限公司

TOLERANCE:		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME:	
X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5*				USB TYPE C 母座24P 板上DIP+SMT L=9.87	
 UNIT: mm [inch]		CHECKED BY:	DATE :	PART NO.	HYCW351-USBC24-115B
		马跃	2014-02-23	MOLD NO.	
		APPROVED BY:	DATE :	DRAW NO:	HYC-2206221559
SCALE:1:1	SIZE: A4	邱敏	2014-02-23	SHEET NO.	1 OF 1